

R08DS0263EJ0100

Rev.1.00

Dec 23, 2021

# PS8502, PS8502L1, PS8502L2, PS8502L3

HIGH SPEED ANALOG OUTPUT TYPE 8-PIN PHOTOCOUPLER

DESCRIPTION

The PS8502, PS8502L1, PS8502L2 and PS8502L3 are 8-pin high speed photocouplers containing an AlGaAs LED on input side and a PN photodiode and a high speed amplifier transistor on output side on one chip. The PS8502 is in a plastic DIP (Dual In-line Package).

The PS8502L1 is lead bending type for long creepage distance.

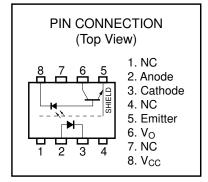
The PS8502L2 is lead bending type for long creepage distance (Gull-wing) for surface mount. The PS8502L3 is lead bending type (Gull-wing) for surface mounting.

# **FEATURES**

- Long creepage distance (8 mm MIN. : PS8502L1, PS8502L2)
- High common mode transient immunity ( $CM_H$ ,  $CM_L = \pm 15 \text{ kV/}\mu \text{s MIN}$ )
- High supply voltage (Vcc = 35 V MAX.)
- High speed response (tphL, tpLH = 0.8  $\mu$ s MAX.)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- TTL, CMOS compatible with a resistor
- Ordering number of tape product : PS8502L2-E3 : 1 000 pcs/reel : PS8502L3-E3 : 1 000 pcs/reel
- Pb-Free product
- Safety standards
- - UL approved: UL1577, Double protection
- CSA approved: CAN/CSA-C22.2 No.62368-1, Reinforced insulation
- - BSI approved: BS EN 62368-1, Reinforced insulation
- - SEMKO approved: EN 62368-1, IEC 62368-1, Reinforced insulation
- NEMKO approved: EN 62368-1, Reinforced insulation
- DEMKO approved: EN 62368-1, Reinforced insulation
- - FIMKO approved: EN 62368-1, Reinforced insulation
- VDE approved: DIN EN 60747-5-5 (Option)

### **APPLICATIONS**

- Interface for measurement or control equipment
- Substitutions for relays and pulse transformers
- Modem, communications device
- General purpose inverter

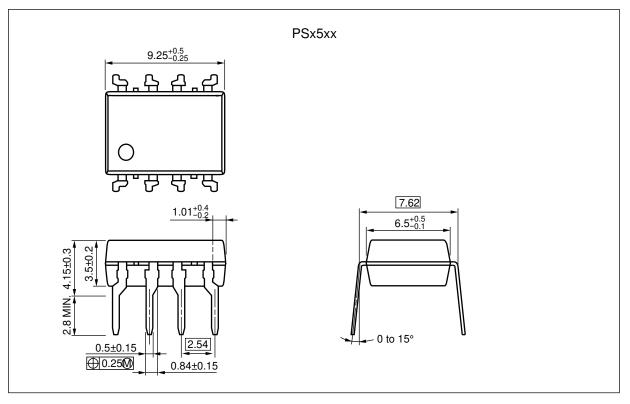


Start of mass production Jun.2006



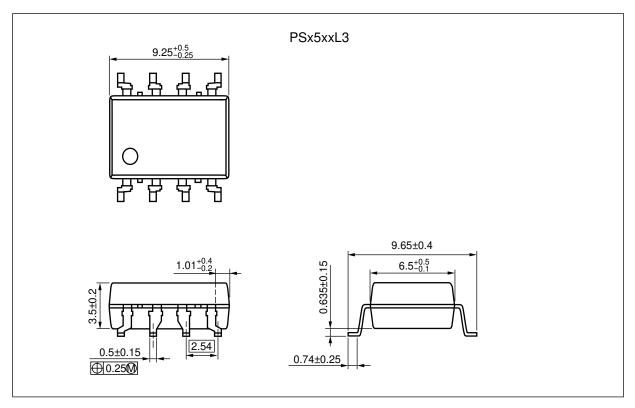
# PACKAGE DIMENSIONS (UNIT: mm)





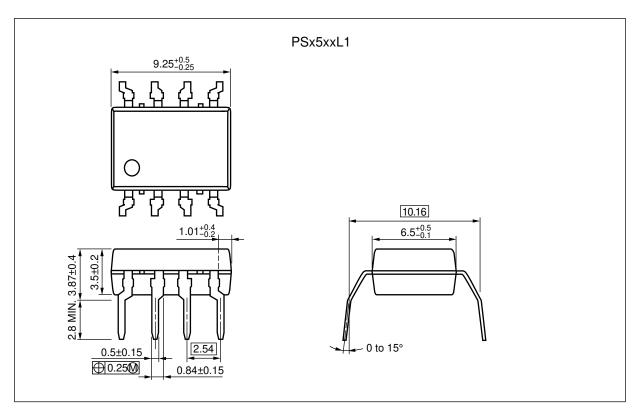
Weight: 0.55g (typ.)

Lead Bending Type (Gull-wing) For Surface Mount

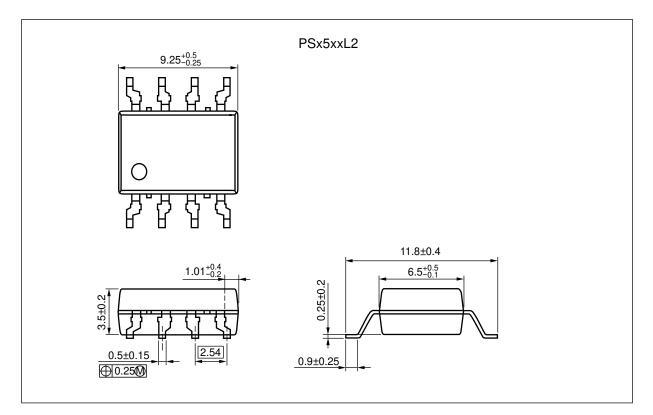




### Lead Bending Type For Long Creepage Distance



Lead Bending Type For Long Creepage Distance (Gull-wing) For Surface Mount

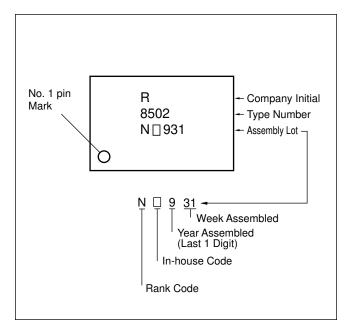




# PHOTOCOUPLER CONSTRUCTION

Parameter	PS8502, PS8502L3	PS8502L1, PS8502L2
Air Distance (MIN.)	7 mm	8 mm
Creepage Distance (MIN.)	7 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm

# MARKING EXAMPLE



# **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1	
PS8502	PS8502-AX	Pb-Free	Magazine case 50 pcs	Standard products	PS8502	
PS8502L1	PS8502L1-AX	(Ni/Pd/Au)		(UL, CSA, BSI, SEMKO, NEMKO,	PS8502L1	
PS8502L2	PS8502L2-AX			DEMKO, FIMKO	PS8502L2	
PS8502L3	PS8502L3-AX			approved)	approved) PS	PS8502L3
PS8502L2-E3	PS8502L2-E3-AX		Embossed Tape 1 000 pcs/reel		PS8502L2	
PS8502L3-E3	PS8502L3-E3-AX				PS8502L3	
PS8502-V	PS8502-V-AX		Magazine case 50 pcs	UL, CSA, BSI, SEMKO, NEMKO, FIMKO, DEMKO, DIN EN 60747-5-5	PS8502	
PS8502L1-V	PS8502L1-V-AX				PS8502L1	
PS8502L2-V	PS8502L2-V-AX				PS8502L2	
PS8502L3-V	PS8502L3-V-AX		approved		PS8502L3	
PS8502L2-V-E3	PS8502L2-V-E3-AX		Embossed Tape 1 000 pcs/reel	]	PS8502L2	
PS8502L3-V-E3	PS8502L3-V-E3-AX				PS8502L3	

Notes\*:1. For the application of the Safety Standard, following part number should be used.



### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current *1	lF	25	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	35	V
	Output Voltage	Vo	35	V
	Output Current	lo	8	mA
	Power Dissipation *2	Pc	100	mW
Isolation Vo	oltage *3	BV	5 000	Vr.m.s.
Operating A	Ambient Temperature	TA	-55 to +100	°C
Storage Te	emperature	T <sub>stg</sub>	-55 to +125	°C

Notes\*:1. Reduced to 0.33 mA/°C at  $T_{\text{A}}$  = 70 °C or more.

2. Reduced to 2.0 mW/°C at  $T_A = 75$  °C or more.

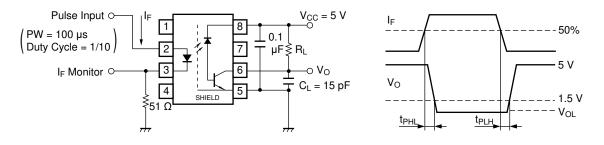
3. AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	I⊧ = 16 mA		1.7	2.2	V
	Reverse Current	IR	V <sub>R</sub> = 3 V			10	μA
	Forward Voltage Temperature Coefficent	<i>∆</i> V <i></i> г/ <i>∆</i> Та	I⊧ = 16 mA		-2.1		mV/°C
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Detector	High Level Output Current	Іон (1)	I⊧ = 0 mA, Vcc = Vo = 5.5 V		3	500	nA
	High Level Output Current	Іон (2)	IF = 0 mA, Vcc = Vo = 35 V			100	μA
	Low Level Output Voltage	Vol	IF = 16 mA, Vcc = 4.5 V, Io = 2.4 mA		0.15	0.4	V
	Low Level Supply Current	Iccl	IF = 16 mA, Vo = Open, Vcc = 35 V		150		μA
	High Level Supply Current	Іссн	IF = 0 mA, Vo = Open, Vcc = 35 V		0.01	1	μA
Coupled	Current Transfer Ratio	CTR	IF = 16 mA, Vcc = 4.5 V, Vo = 0.4 V	15			%
	Isolation Resistance	R⊦o	VI-O = 1 KVDC	10 <sup>11</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.7		pF
	Propagation Delay Time $(H \rightarrow L)^{*2}$	tph∟	${\sf I}_{\sf F}$ = 16 mA, Vcc = 5 V, RL = 1.9 k $\Omega$		0.22	0.8	μs
	Propagation Delay Time $(L \rightarrow H)^{*2}$	<b>t</b> plh	I⊧ = 16 mA, Vcc = 5 V, R∟ = 1.9 kΩ		0.35	0.8	μs
	Common Mode Transient Immunity at High Level Output <sup>*3</sup>	СМн	$I_{\text{F}} = 0 \text{ mA}, \text{ V}_{\text{CC}} = 5 \text{ V}, \text{ V}_{\text{CM}} = 1.5 \text{ kV},$ $R_{\text{L}} = 4.1 \text{ k}\Omega$	15			kV/μs
	Common Mode Transient Immunity at Low Level Output <sup>*3</sup>	CM∟	IF = 16 mA, Vcc = 5 V, Vcm = 1.5 kV, RL = 4.1 kΩ	-15			kV/μs

# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

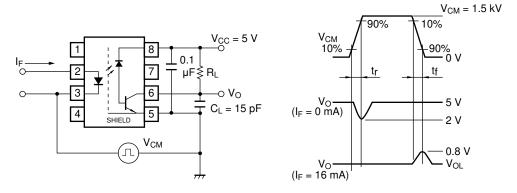
Notes\*:1. Typical values at  $T_A = 25 \text{ °C}$ .

2. Test circuit for propagation delay time



Remark: C<sub>L</sub> includes probe and stray wiring capacitance.

3. Test circuit for common mode transient immunity



Remark: CL includes probe and stray wiring capacitance.

### **USAGE CAUTIONS**

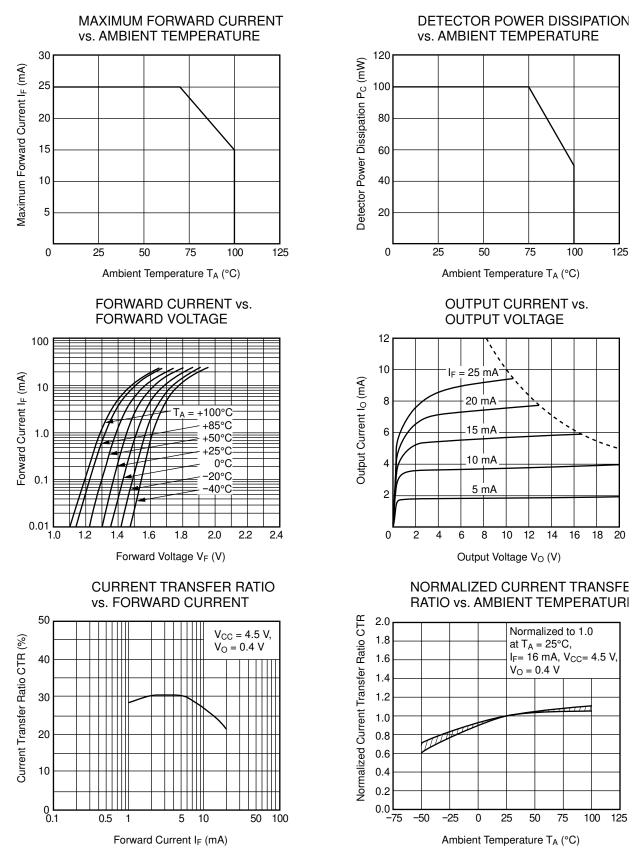
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1  $\mu$ F is used between V<sub>CC</sub> and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- Pins 1, 4 (which is an NC<sup>\*1</sup> pin) can either be connected directly to the GND pin on the LED side or left open. Also, Pin 7 (which is an NC<sup>\*1</sup> pin) can either be connected directly to the GND pin on the detector side or left open.

Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

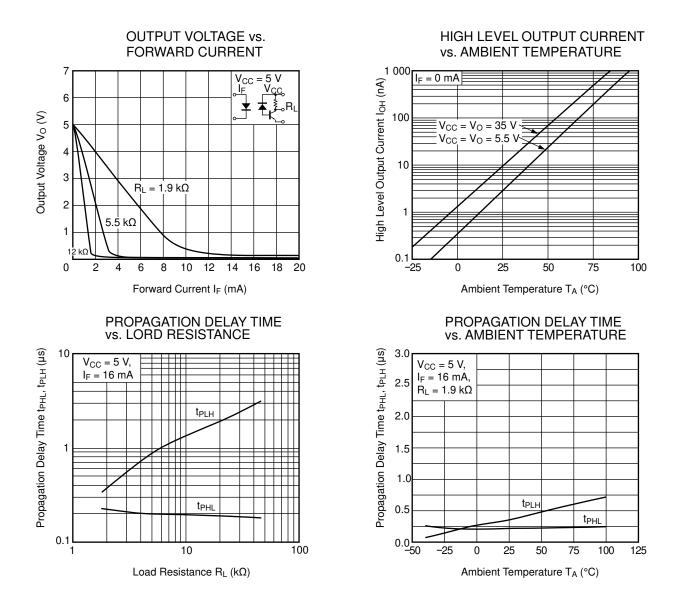
- \*1 NC: Non-Connection (No Connection)
- 4. Avoid storage at a high temperature and high humidity.
- 5. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 6. Do not use fixing agents or coatings containing halogen-based substances.



# **TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C unless otherwise specified)**



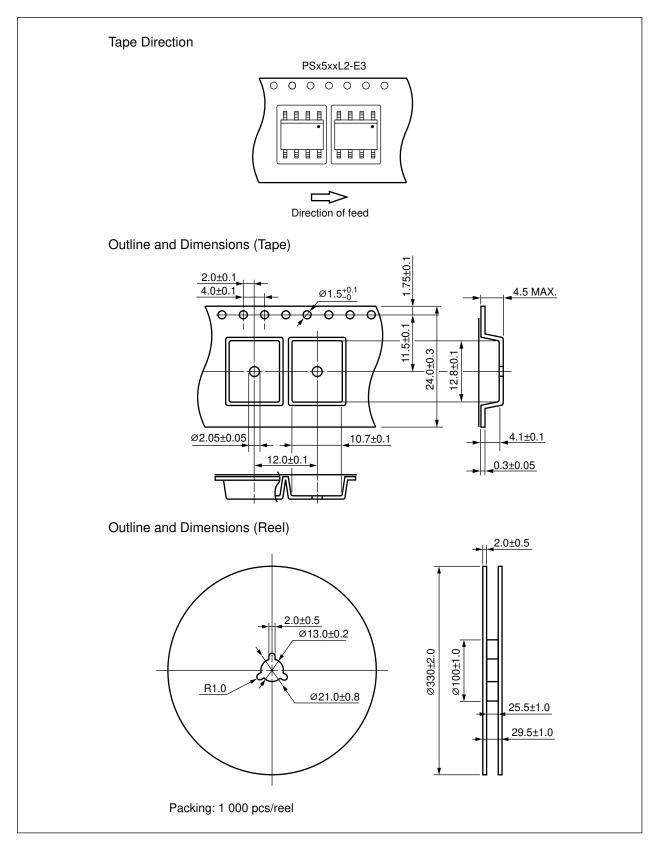


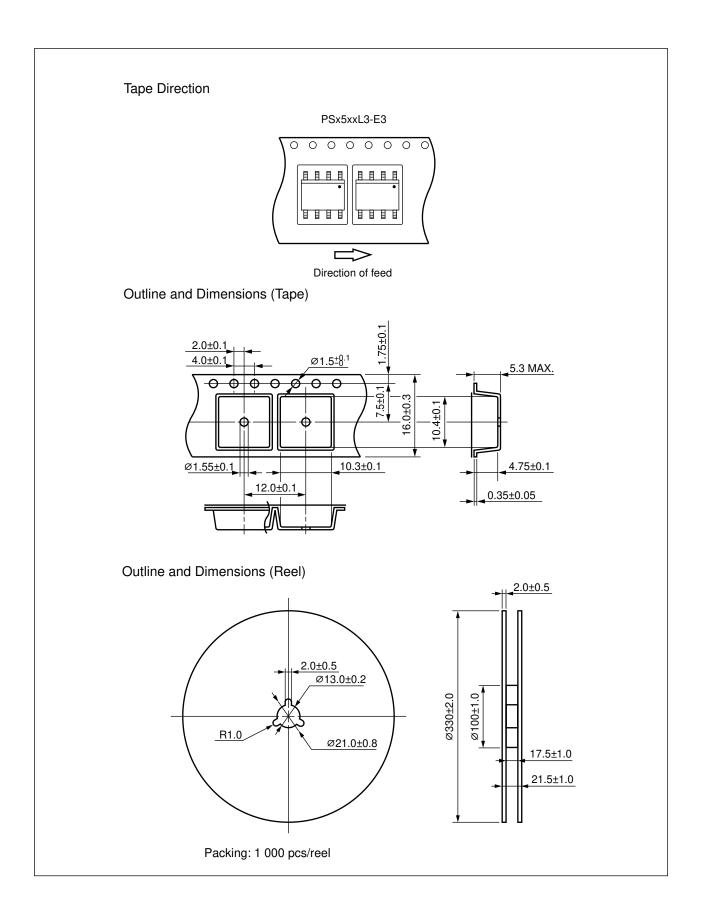


Remark The graphs indicate nominal characteristics.

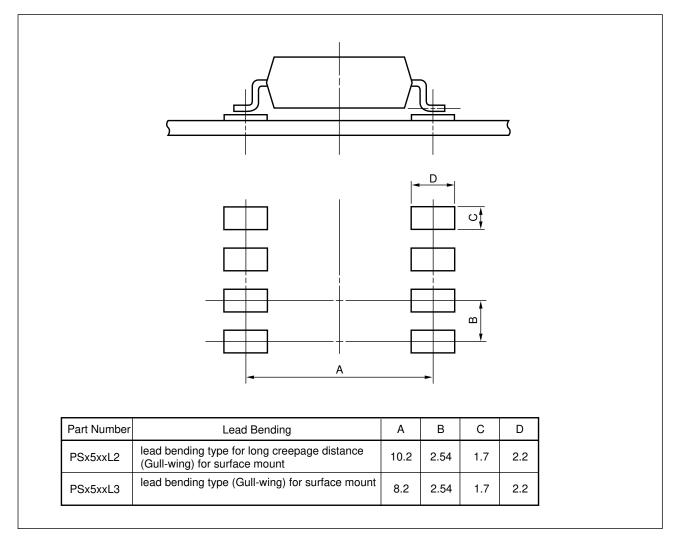


# TAPING SPECIFICATIONS (UNIT: mm)





# **RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)**



Remark All dimensions in this figure must be evaluated before use.



# NOTES ON HANDLING

- 1. Recommended soldering conditions
  - (1) Infrared reflow soldering
    - Peak reflow temperature
    - · Time of peak reflow temperature
    - Time of temperature higher than 220 °C
    - Time to preheat temperature from 120 to 180 °C 120±30 s
    - Number of reflows
    - Flux

# Three

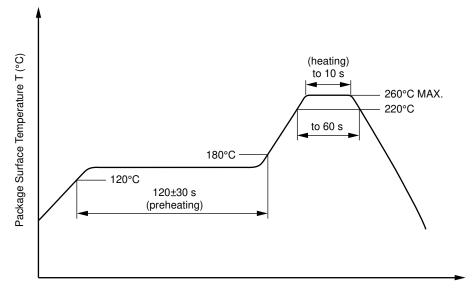
10 seconds or less

60 seconds or less

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

260 °C or below (package surface temperature)

### Recommended Temperature Profile of Infrared Reflow



Time (s)

- (2) Wave soldering
  - Temperature 260 °C or below (molten solder temperature)
  - Time 10 seconds or less
  - Preheating conditions 120 °C or below (package surface temperature)
  - One (Allowed to be dipped in solder including plastic mold portion.) Number of times
  - Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### (3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350 °C or below
- Time (each pins) 3 seconds or less
- Flux
- Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100 °C
- (4) Cautions
  - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

Do not use fixing agents or coatings containing halogen-based substances.

# 2. Cautions regarding noise

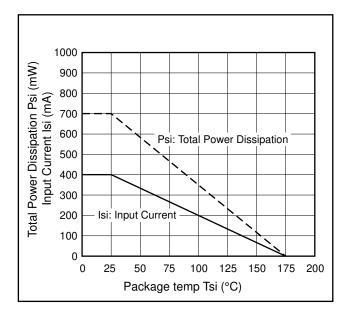
Be aware that when voltage is applied suddenly between the photocoupler's input and output or between V<sub>CC</sub>-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.



# SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

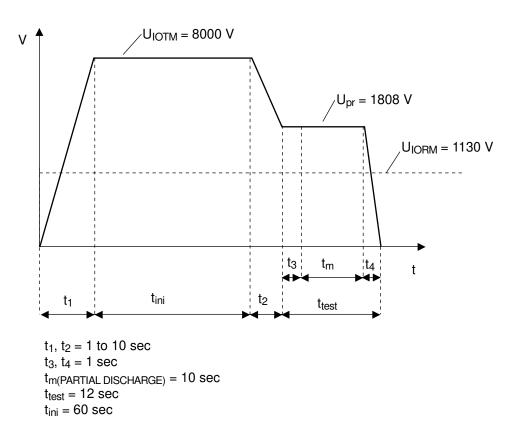
Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	1 130	Vpeak
Test voltage (partial discharge test, procedure a for type test and random test)	Upr	1 695	V peak
$U_{pr} = 1.6 \times U_{IORM}, P_d < 5 pC$	<b>O</b> pi	1 000	• peak
Test voltage (partial discharge test, procedure b for all devices)	Upr	2 119	Vpeak
$U_{pr} = 1.875 \times U_{IORM}, P_d < 5 pC$	Opi	2113	v peak
Highest permissible overvoltage	Uютм	8 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE 0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE 0110 Part 1)		III a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-55 to +100	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V} \text{ dc} \text{ at } T_A = 25 ^{\circ}\text{C}$	Ris MIN.	10 <sup>12</sup>	Ω
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> MAX. at least 100 °C	Ris MIN.	10 <sup>11</sup>	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	175	°C
Current (input current IF, Psi = 0)	Isi	400	mA
Power (output or total power dissipation)	Psi	700	mW
Isolation resistance			
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> = Tsi	Ris MIN.	10 <sup>9</sup>	Ω

# Dependence of maximum safety ratings with package temperature

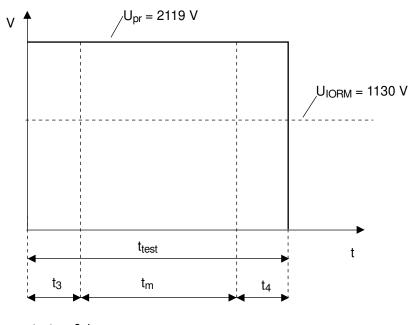




### Method a) Destructive Test, Type and Sample Test



### Method b) Non-destructive Test, 100% Production Test



 $\begin{array}{l} t_{3}, t_{4} = 0.1 \; \text{sec} \\ t_{m}(\text{PARTIAL DISCHARGE}) = 1.0 \; \text{sec} \\ t_{test} = 1.2 \; \text{sec} \end{array}$ 

<b>Caution</b> GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or i any way allow it to enter the mouth.

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